#### 11/12/2015 503567303

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT3613930

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
KHOSRO MOHAMMAD RABII	06/12/2015
VIJAY NAICKER SUBRAMANIAM	08/03/2015
RICHARD DOMINIC WIETFELDT	06/12/2015
FAWAD SHAUKAT	06/12/2015
SHIVAKUMAR BALASUBRAMANYAM	10/11/2015

### **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

### **PROPERTY NUMBERS Total: 1**

Property Type	Number		
Application Number:	14734824		

### **CORRESPONDENCE DATA**

Fax Number: (651)735-1102

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6517351100

Email: pairdocketing@ssiplaw.com **Correspondent Name:** SHUMAKER & SIEFFERT, P.A. 1625 RADIO DRIVE, SUITE 300 Address Line 1: Address Line 4: WOODBURY, MINNESOTA 55125

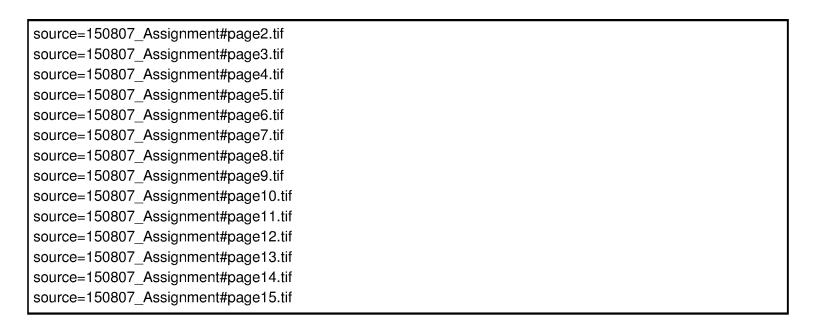
ATTORNEY DOCKET NUMBER:	1414-004US01
NAME OF SUBMITTER:	SUSAN J. DALY
SIGNATURE:	/Susan J. Daly/
DATE SIGNED:	11/12/2015

**Total Attachments: 15** 

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**PATENT** REEL: 037027 FRAME: 0430

503567303



### WHEREAS, WE,

- 1. Khosro Mohammad Rabii, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, CA,
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- 3. Richard Dominic Wietfeldt, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, CA,
- 4. Fawad Shaukat, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, CA,
- 5. Shivakumar Balasubramanyam, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **TUNNELING HDMI DATA OVER WIRELESS CONNECTIONS** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 14/734,824 filed June 09, 2015, Qualcomm Reference No. 150807, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

Done at _	LOCATION D	, on <u>(</u>		Khosro Mohammad Rabii
Done at	LOCATION	, on	DATE	Vijay Naicker Subramaniam
Done at _	LOCATION	, on	DATE	Richard Dominic Wietfeldt
Done at _	LOCATION	, on	DATE	Fawad Shankat
Done at	LOCATION	_, on	DATE	Shivakumar Balasubramanyam

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Done at _	, or	<b>1</b>	
	LOCATION	DATE	Khosro Mohammad Rabii
Done at _	Sm Diego, of	3 3 5	- Xin Vailo
	LOCATION	1.9% 1.13	Vijdy Micked Subramaniam
Done at _	LOCATION	<u> </u>	
	LOCATION	DATE	Richard Dominic Wietfeldt
**			
Done at	LOCATION , OF	DATE	Fawad Shaukat
Dane at	, or		
en (NOSE) ett	LOCATION	DATE	Shivakumar Balasubramanyam

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Done at	, on		Note and All and the second second
EXICATIO	N	DATE	Vijay Neicker Subremesiam
Done at Jan (1900 0	1 , on <i>L</i>	112/15	<u> / U.S.O. one Vid/U/-</u> Richard Dominic Wietfeldt
LOĈATIO	N	DATE	Richard Dominic Wietfeldt
Done at	; (CE)		
LOCATIO	N	DATE	Fawad Shaukat
Done at	, on		
LOCATIO	N	DATE	Shivakamar Balasabramanyam

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Done at		, on		
	LOCATION	·····	DATE	Khosro Mohammad Rabii
Done at	LOCATION	On	DATE	Vijay Naicker Subramaniam
Done at	LOCATION	on	DATE	Richard Dominic Wietfeldt
	ZNDI 200 LOCATION			Jan
				Pawad Shaukat
Done at _	LOCATION	, on		
	LOCATION		DATE	Shivakumar Balasuhramanyam

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Done at	, on	
LOCATIO		Khosro Mohammad Rabii
Done atLOCATIO		Vijay Naicker Subramaniam
Done atLOCATIO	on DATE	Richard Dominic Wietfeldt
Done at LOCATIO		Fawad Shaukat
Done at SAN 01	<u>E6.3</u> , on <u>10-11-15</u> DN DATE	Shivakumar Balasubramanyam

**RECORDED: 11/12/2015**